ASSOCIATION CONNEC	© Copyright 2005, IPO	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						s and Mfg	nformation	on	
Supplier Infor	rmation														
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*			
onsemi												2025-06-04			
Contact Name		Title - Contact			F	Phone - Contact*				I	Email - Contact*				
Product-Env-Ste	wards	Product Enviro Compliance			]	NA					Product-Env-Stewards@onsemi.com				
authorized Repre	esentative*	Title - Representative			F	Phone - Representative*				I	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com			
Reque	ester Item Number	Mfr Iten	Item Number Mfr Item Name				Effective Date	e Version	Version Manufacturing Site		Site	We	ight*	UOM	Unit Type
		MM74HCT00MTCX		QUAD 2 INPUT NAND GATE			2025-06-04 PH1		H1			4.823 mg		Each	
<b>Ianufacturin</b>	g Proccess Informati	on						,							
Termin	l Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MS	L Rating	Peak Process Body Temperature		e Max Time	Max Time at Peak Temper		are Number of Reflow Cycles		eles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		Au) (no	CU Alloy 1		1		260		C 30			seconds	onds 3		
Comments					<u> </u>					<u> </u>					
vel 1 - maximun	n time at peak temperatur	e during so	ldering is 10-3	0 seconds											
or more informa	ation regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.496	mg	Supplier	Silicon (Si)	7440-21-3		0.496	mg
Die Attach	0.055	mg	Supplier	Silver (Ag)	7440-22-4		0.044	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.011	mg
Lead Frame	21.563	_	Supplier	Magnesium (Mg)	7439-95-4		0.032	mg
			Supplier	Silicon (Si)	7440-21-3		0.14	mg
			В	Nickel (Ni)	7440-02-0		0.691	mg
			Supplier	Copper (Cu)	7440-50-8		20.7	mg
Mold Compound-Black	32.2	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.44	mg
			Supplier	Carbon Black (C)	1333-86-4		0.322	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		25.438	mg
Plating	0.161	mg	Supplier	Palladium (Pd)	7440-05-3		0.005	mg
			В	Nickel (Ni)	7440-02-0		0.153	mg
			Supplier	Gold (Au)	7440-57-5		0.003	mg
Wire Bond - Au	0.348	mg	Supplier	Gold (Au)	7440-57-5		0.348	mg